

## Product Summary

Symbol	Value	Unit
$I_{T(RMS)}$	0.8	A
$V_{DRM} V_{RRM}$	600	V
$I_{GT}$	10~200	$\mu A$

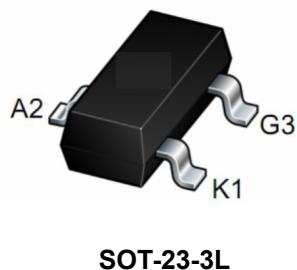
## Feature

With high ability to withstand the shock loading of large current, Provide high dv/dt rate with strong resistance to electromagnetic interference.

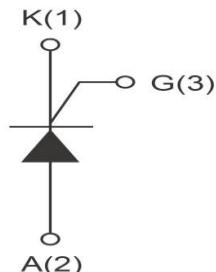
## Application

Power charger, T-tools, massager, solid state relay, AC Motor speed regulation and so on.

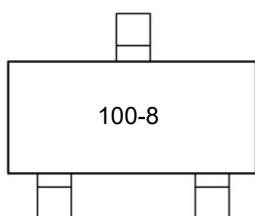
## Package



## Circuit diagram



## Marking



**Absolute maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Repetitive peak off-state voltage	V <sub>DRM</sub>	600	V
Repetitive peak reverse voltage	V <sub>RRM</sub>	600	V
RMS on-state current	I <sub>T(RMS)</sub>	0.8	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)	I <sub>TSM</sub>	8	A
I <sup>2</sup> t value for fusing (tp=10ms)	I <sup>2</sup> t	0.35	A <sup>2</sup> s
Critical rate of rise of on-state current (I <sub>G</sub> =2×I <sub>GT</sub> )	dI <sub>T</sub> /dt	50	A/μs
Peak gate current	I <sub>GM</sub>	0.2	A
Average gate power dissipation	P <sub>G(AV)</sub>	0.1	W
Junction Temperature	T <sub>J</sub>	-40 ~ +110	°C
Storage Temperature	T <sub>STG</sub>	-40 ~ +150	°C

**Electrical characteristics (T<sub>A</sub>=25 °C, unless otherwise noted)**

Parameter	Symbol	Test Condition	Value		Unit
			Min	Max	
Gate trigger current	I <sub>GT</sub>	V <sub>D</sub> =12V I <sub>T</sub> =10mA T <sub>j</sub> =25°C	10	200	μA
Gate trigger voltage	V <sub>GT</sub>		-	0.8	V
Gate non-trigger voltage	V <sub>GD</sub>	V <sub>D</sub> =1/2V <sub>DRM</sub> T <sub>j</sub> =110°C	0.2	-	V
latching current	I <sub>L</sub>	V <sub>D</sub> =12V I <sub>G</sub> =0.5mA R <sub>GK</sub> =1kΩ T <sub>j</sub> =25°C	-	4	mA
Holding current	I <sub>H</sub>		-	5	mA
Critical-rate of rise of commutation voltage	dV <sub>D</sub> /dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =110°C	10	-	V/μs

**STATIC CHARACTERISTICS**

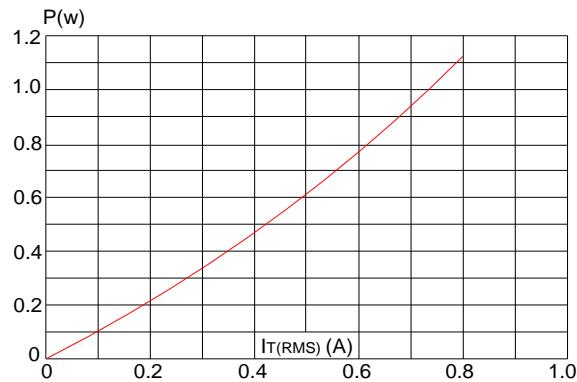
Forward "on" voltage	V <sub>TM</sub>	I <sub>TM</sub> =1.2A tp=380μs		-	1.7	V	
Repetitive Peak Off-State Current	I <sub>DRM</sub>	V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub>		T <sub>j</sub> =25 °C	-	10	μA
Repetitive Peak Reverse Current	I <sub>RRM</sub>			T <sub>j</sub> =110 °C	-	0.1	mA

**THERMAL RESISTANCES**

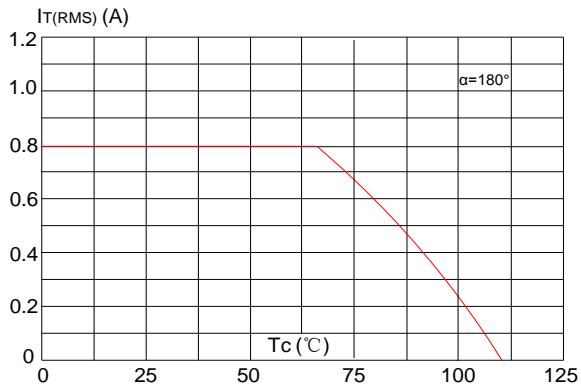
Thermal resistance	R <sub>th(j-c)</sub>	Junction to case		TYP.	75	°C/W
	R <sub>th(j-a)</sub>	Junction to ambient		TYP.	150	°C/W

## Typical Characteristics

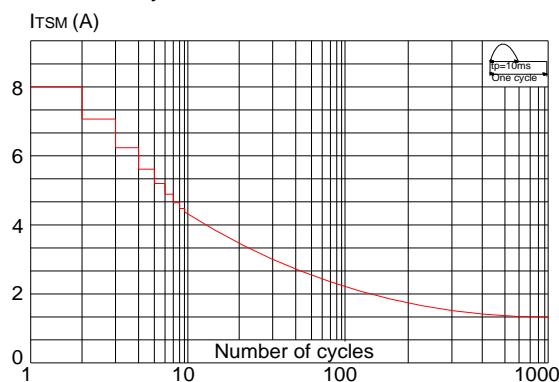
**FIG.1** Maximum power dissipation versus RMS on-state current



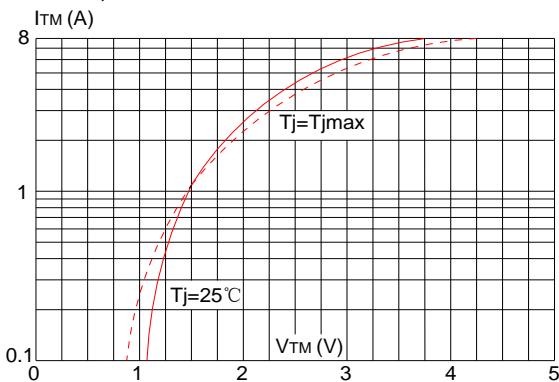
**FIG.2:** RMS on-state current versus case temperature



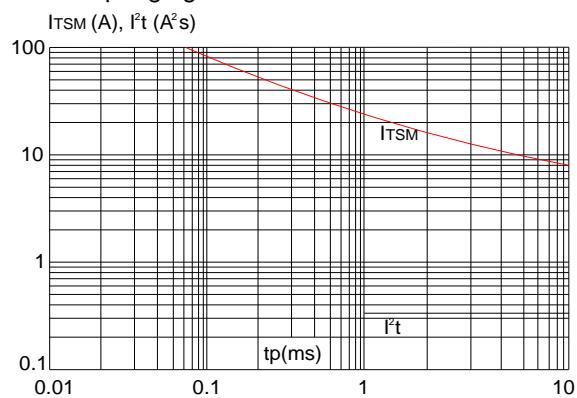
**FIG.3:** Surge peak on-state current versus number of cycles



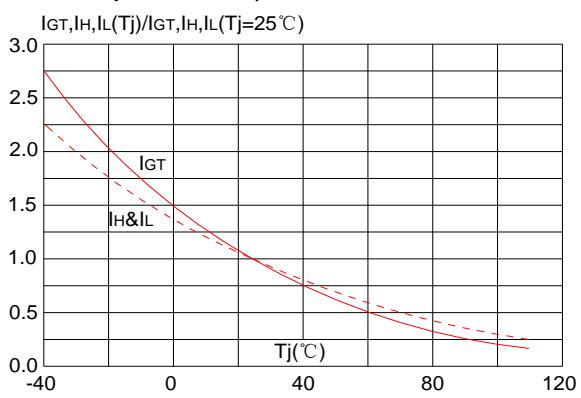
**FIG.4:** On-state characteristics (maximum values)

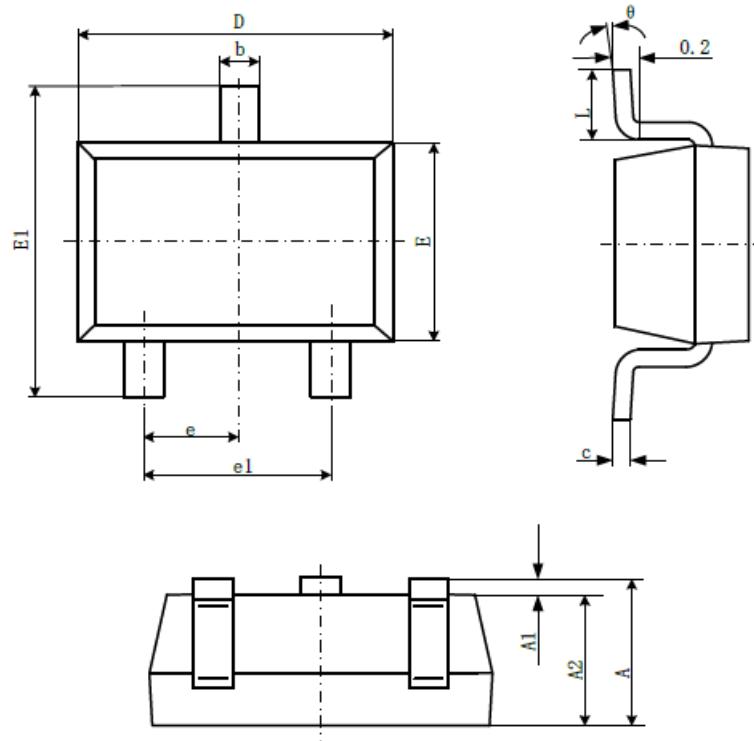


**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10\text{ms}$ , and corresponding value of  $I^2t$



**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature



**SOT-23-3L Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°